Product data sheet

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NXP Semiconductors



HF power MOS transistor

BLF145

FEATURES

- · High power gain
- · Low noise figure
- · Good thermal stability
- · Withstands full load mismatch.

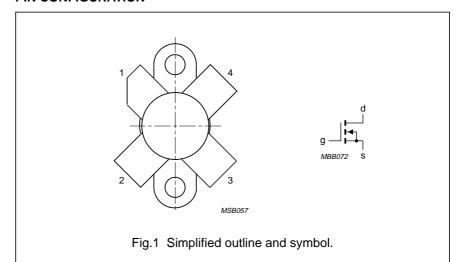
DESCRIPTION

Silicon N-channel enhancement mode vertical D-MOS transistor designed for SSB transmitter applications in the HF frequency range. The transistor is encapsulated in a 4-lead, SOT123A flange package, with a ceramic cap. All leads are isolated from the flange. Matched gate-source voltage (V_{GS}) groups are available on request.

PINNING - SOT123A

PIN	DESCRIPTION				
1	drain				
2	source				
3	gate				
4	source				

PIN CONFIGURATION



CAUTION

This product is supplied in anti-static packing to prevent damage caused by electrostatic discharge during transport and handling. For further information, refer to Philips specs.: SNW-EQ-608, SNW-FQ-302A, and SNW-FQ-302B.

WARNING Product and environmental safety - toxic materials

This product contains beryllium oxide. The product is entirely safe provided that the BeO disc is not damaged. All persons who handle, use or dispose of this product should be aware of its nature and of the necessary safety precautions. After use, dispose of as chemical or special waste according to the regulations applying at the location of the user. It must never be thrown out with the general or domestic waste.

QUICK REFERENCE DATA

RF performance at $T_h = 25$ °C in a common source test circuit.

MODE OF OPERATION	f (MHz)	V _{DS} (V)	I _D (A)	P _L (W)	G _p (dB)	η ρ (%) ⁽¹⁾	d ₃ (dB)
SSB, class-A	28	28	1.3	8 (PEP)	>24	_	<-40
SSB, class-AB	28	28	_	30 (PEP)	typ. 20	typ. 40	typ35

Note

1. 2-tone efficiency.

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LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{DSS}	drain-source voltage		_	65	V
V _{GSS}	gate-source voltage		_	±20	V
I _D	drain current (DC)		_	6	Α
P _{tot}	total power dissipation	T _{mb} ≤ 25 °C	_	68	W
T _{stg}	storage temperature		-65	150	°C
Tj	junction temperature		_	200	°C

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	VALUE	UNIT
R _{th j-mb}	thermal resistance from junction to mounting base	2.6	K/W
R _{th mb-h}	thermal resistance from mounting base to heatsink	0.3	K/W

10 I_D (A)

1

10⁻¹ 1 10

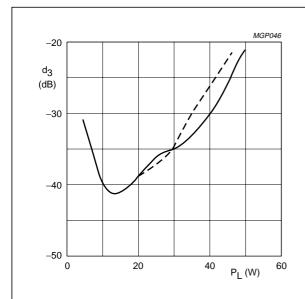
Fig.2 DC SOAR.

⁽¹⁾ Current is this area may be limited by R_{DSon} .

⁽²⁾ $T_{mb} = 25 \, ^{\circ}C$.

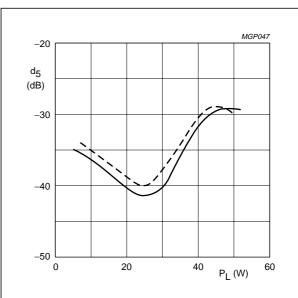
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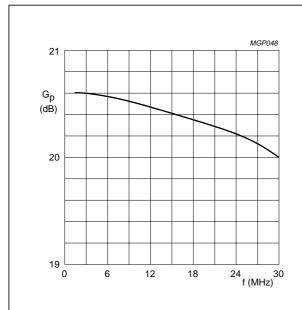
Class-AB operation; V_{DS} = 28 V; I_{DQ} = 0.25 A; R_{th mb-h} = 0.3 K/W; f = 28 MHz. solid line: T_h = 25 °C. dotted line: T_h = 70 °C.

Fig.15 Third order intermodulation distortion as a function of load power, typical values.



Class-AB operation; V_{DS} = 28 V; I_{DQ} = 0.25 A; R_{th mb-h} = 0.3 K/W; f = 28 MHz. solid line: T_h = 25 °C. dotted line: T_h = 70 °C.

Fig.16 Fifth order intermodulation distortion as a function of load power, typical values.



Class-AB operation; V_{DS} = 28 V; I_{DQ} = 0.25 A; P_L = 30 W; T_h = 25 °C; R_{th mb-h} = 0.3 K/W; R₁ = 34 Ω ; Z_L = 8.9 + j1 Ω .

Fig.17 Power gain as a function of frequency, typical values.

Table 1 Input impedance as a function of frequency Class-AB operation; $V_{DS} = 28 \text{ V}$; $I_{DQ} = 0.25 \text{ A}$; $P_L = 30 \text{ W}$; T_h = 25 °C; $R_{th\ mb\text{-}h}$ = 0.3 K/W; R1 = 34 $\Omega;$ $Z_{L} = 8.9 + j1 \Omega$.

f (MHz)	Z _i (Ω)
1.5	32.9 – j2.2
3.0	32.4 – j4.3
6.0	30.7 – j8.1
10	27.4 – j11.9
15	32.9 – j14.6
20	18.5 – j15.4
25	15.1 – j15.3
30	12.5 – j14.6

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BLF145 scattering parameters

 $V_{DS} = 28 \text{ V}; I_D = 250 \text{ mA}; \text{note 1}$

f	f \$ ₁₁		S	21	S	12	s	22
(MHz)	s ₁₁	∠Φ	s ₂₁	∠Φ	s ₁₂	∠Φ	s ₂₂	∠Φ
5	0.90	-70.90	62.40	138.40	0.02	49.80	0.83	-67.60
10	0.81	-108.90	42.47	117.90	0.03	30.70	0.72	-105.00
20	0.76	-140.20	23.90	100.40	0.03	16.40	0.66	-135.80
30	0.75	-151.90	16.27	92.20	0.03	10.50	0.65	-147.90
40	0.75	-157.90	12.18	86.50	0.03	8.00	0.64	-153.40
50	0.75	-161.40	9.70	82.00	0.03	6.60	0.65	-156.40
60	0.76	-163.70	8.01	78.10	0.03	5.80	0.66	-158.30
70	0.77	-165.30	6.78	74.50	0.03	5.60	0.67	-159.70
80	0.77	-166.60	5.85	71.30	0.03	6.20	0.68	-160.50
90	0.78	-167.50	5.14	68.30	0.02	7.30	0.69	-161.20
100	0.79	-168.40	4.56	65.30	0.02	8.80	0.71	-162.00
125	0.81	-170.40	3.48	58.20	0.02	15.50	0.74	-163.70
150	0.83	-172.00	2.74	52.50	0.02	27.00	0.77	-164.90
175	0.85	-173.60	2.23	47.70	0.02	41.30	0.80	-166.20
200	0.87	-175.20	1.86	43.00	0.02	54.50	0.82	-168.00
250	0.89	-178.40	1.32	35.30	0.03	72.80	0.86	-171.20
300	0.91	178.50	1.00	29.70	0.04	80.50	0.89	-174.20
350	0.93	175.50	0.77	25.50	0.05	83.90	0.91	-177.10
400	0.94	172.60	0.62	22.90	0.06	84.80	0.93	-179.90
450	0.94	169.90	0.50	20.90	0.07	85.30	0.94	177.60
500	0.95	167.20	0.43	20.30	0.08	84.20	0.94	175.10
600	0.95	161.90	0.32	21.60	0.10	82.40	0.95	170.60
700	0.95	156.80	0.26	25.40	0.12	79.90	0.96	166.40
800	0.94	151.90	0.23	31.50	0.14	78.20	0.96	162.30
900	0.94	147.20	0.22	38.60	0.16	74.10	0.94	158.60
1000	0.94	142.10	0.23	48.40	0.15	75.40	0.94	162.10

Note

^{1.} For more extensive s-parameters see internet: http://www.semiconductors.philips.com/markets/communications/wirelesscommunication/broadcast.

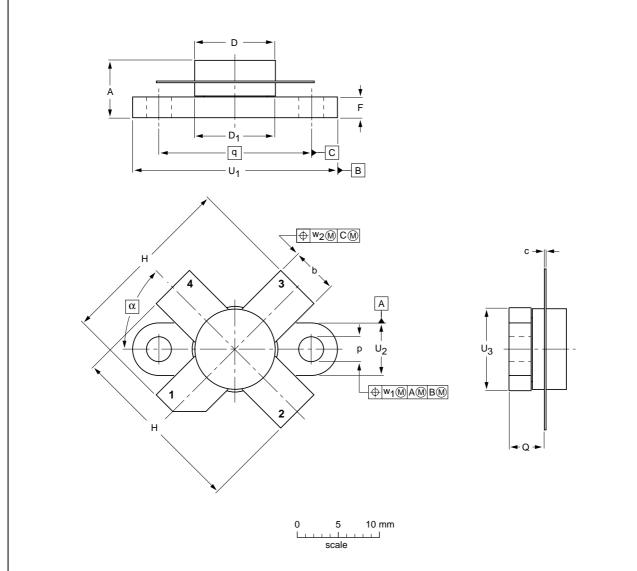
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PACKAGE OUTLINE

Flanged ceramic package; 2 mounting holes; 4 leads

SOT123A



DIMENSIONS (millimetre dimensions are derived from the original inch dimensions)

UNIT	Α	b	С	D	D ₁	F	Н	р	Q	q	U ₁	U ₂	U ₃	w ₁	w ₂	α
mm	7.47 6.37	5.82 5.56	0.18 0.10	9.73 9.47	9.78 9.42	2.72 2.31	20.71 19.93	3.33 3.04	4.63 4.11	18.42	24.87 24.64	6.48 6.22	9.78 9.39	0.25	0.51	45°
inches	0.294 0.251	0.229 0.219		0.383 0.373		0.107 0.091		0.131 0.120			0.980 0.970	0.255 0.245	0.385 0.370	0.010	0.020	45

OUTLINE		REFER	EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	EIAJ	PROJECTION	1330E DATE
SOT123A					99-03-29

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Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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BLF145 NXP Semiconductors

HF power MOS transistor

Revision history

Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BLF145_N_4	20070105	Product data sheet	-	BLF145_3
Modifications:		nade to note 2 on page 8 nade to note 2 on page 10		
BLF145_3 (9397 750 11581)	20031013	Product specification	-	BLF145_CNV_2
BLF145_CNV_2 (9397 750 xxxxx)	19971212	Product specification	-	-

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